

BCM

Product Change Notice

PCN Type: ■HW/SYS	S/Kit ■BIOS/LAN/F	W □Package	e/Label □Dr	iver/OS	□Acc.	□Others	Page: <u>1</u> of <u>1</u>
PCN Number: P2219	Revision: A		Date of Publication: 05/11/2022				
PRODUCT NAME	PRODUCT PART#	OLD — RE	V. — NEW			REVISION :	TYPE
RX110H	71172-IA	2.3	2.4	Hardwa	are		
		1.20	1.50	DIOC			

REASON OF CHANGE:

Current Infineon p/n SLB9665TT2.0 Trust Module Platform (TPM) is constrained and significantly extending production lead-times.

DESCRIPTION OF CHANGE:

Change to use Intel® Platform Trust Technology TCG TPM 2.0

IMPACT OF CHANGE AND RECOMMEND ACTION:

BCM is recommending our customer to perform additional qualification of this changes.

AFFECTED BY THIS CHANGE		
Specification	YES	
Packaging	NO	
Labeling	NO	
BIOS	YES	
Driver	NO**	
Hardware	YES	

^{**}Microsoft Windows 10 and 11 Operating Systems have the driver built in.

CUT IN DATE:

Date: March, 2023*

OR **Lot#**:

*Cut in date is based on the current forecast.

Parts Disposition	Rework	As Is	Scrap
New Order	Χ		
In Process		Х	
Finished Goods		Х	
RMA		Х	

This PCN had been **QUALIFIED** and **APPROVED** by BCM Engineering Department on 05/09/2022.

This PCN had been **APPROVED** by BCM Procurement Department on May, 2022.

APPROVED BY

VP OF SALES	<approved></approved>	05/11/2022

Signature Date

Doc#: F-G0-0-007A